

P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (TYP.) (nC)		
	0.450 at V _{GS} = -4.5 V	-0.55			
-20	0.500 at V _{GS} = -2.5 V	-0.50	1		
	0.600 at V _{GS} = -1.8 V	-0.38]		

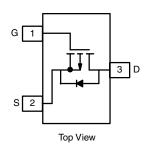
FEATURES

- TrenchFET® power MOSFET
- 100 % R tested
- Fast switching speed

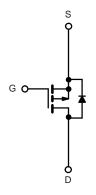


APPLICATIONS

- Load / power switch for portable devices
- Drivers: relays, solenoids, displays
- Battery operated systems







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	-20	.,
Gate-Source Voltage		V _{GS}	± 12	V
	T _A = 25 °C		-0.55 b, c	
Continuous Drain Current (T _J = 150 °C)	T _A = 70 °C	I _D	-0.45 ^{b, c}	
Pulsed Drain Current (t = 300 μs)		I _{DM}	-1.8	A
Continuous Source-Drain Diode Current T _A = 25 °C		I _S	-0.16 b, c	
Marian and Daniel Distriction	T _A = 25 °C	Б	0.19 ^{b, c}	14/
Maximum Power Dissipation	T _A = 70 °C	P _D	0.12 ^{b, c}	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient ^{a, b}	t ≤ 5 s	R _{thJA} 440 540	530	°C/W	
Maximum Junction-to-Ambient 4,7	Steady State		540	650	C/W

Notes

- a. Maximum under steady state conditions is 650 °C/W.
- b. Surface mounted on 1" x 1" FR4 board.
- $c. \ t=5 \ s.$

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} = 0, I _D = -250 μA	-20	_	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	∆V _{DS} /T _J		-12	-	m\//°C	
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J	I _D = -250 μA	-	1.8	-	mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.4	-	-1	V	
Cata Sauraa Laakaga	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 30		
Gate-Source Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$	-	-	± 1		
Zoro Goto Voltago Drain Current	l	V _{DS} = -20 V, V _{GS} = 0 V	-	-	-1	— μA —	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V, T _J = 85 °C	-	-	-10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-1.5	-	-	Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -0.4 \text{ A}$	-	0.450	-		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -0.2 \text{ A}$	-	0.500	-	Ω	
		$V_{GS} = -1.8 \text{ V}, I_D = -0.1 \text{ A}$	-	0.600	-		
Forward Transconductance	9fs	$V_{DS} = -10 \text{ V}, I_D = 0.4 \text{ A}$	-	1	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	45	-		
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	15	-	pF	
Reverse Transfer Capacitance	C _{rss}		-	10	-		
Total Gate Charge	0	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -0.4 \text{ A}$	-	1.65	2.50		
Total Gate Charge	Qg		-	1	2	nC	
Gate-Source Charge	Q_{gs}	V_{DS} = -0 V, V_{GS} = -2.5 V, I_D = -0.4	-	0.2	ı	110	
Gate-Drain Charge	Q_{gd}		-	0.26	ı		
Gate Resistance	R_g	f = 1 MHz	2.4	12	24	Ω	
Turn-On Delay Time	t _{d(on)}		-	9	18		
Rise Time	t _r	V_{DD} = -10 V, R_L = 33.3 Ω	-	10	20		
Turn-Off DelayTime	t _{d(off)}	$I_D\cong$ -0.3 A, $V_{GEN}=$ -4.5 V, $R_g=$ 1 Ω	-	10	20]	
Fall Time	t _f		-	8	16	ns	
Turn-On Delay Time	t _{d(on)}		-	1	2	115	
Rise Time	t _r	V_{DD} = -10 V, R_L = 33.3 Ω	-	8	16		
Turn-Off DelayTime	t _{d(off)}	$I_D\cong$ -0.3 A, $V_{GEN}=$ -8 V, $R_g=$ 1 Ω	-	9	18		
Fall Time	t _f		-	5	10		
Drain-Source Body Diode Characteris	tics						
Pulse Diode Forward Current ^a	I _{SM}		-	-	-1.5	Α	
Body Diode Voltage	V_{SD}	I _S = -0.3 A	-	-0.8	-1.2	V	
Body Diode Reverse Recovery Time	t _{rr}		-	16	24	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L 0.2.4 dl/d+ 100.4/	-	8	16	nC	
Reverse Recovery Fall Time	ta	I _F = -0.3 A, dl/dt = 100 A/μs	-	11	-		
Reverse Recovery Rise Time			_	5	-	ns	

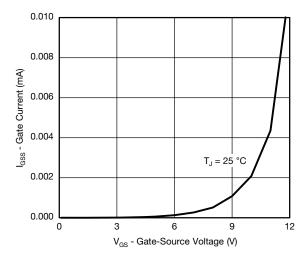
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

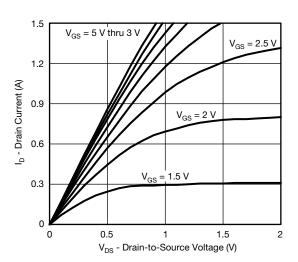
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



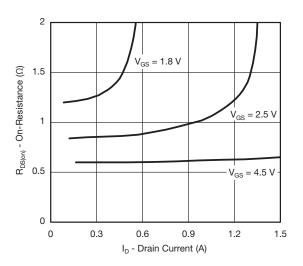
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



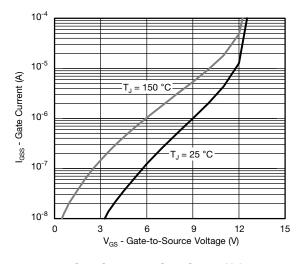
Gate Current vs. Gate-Source Voltage



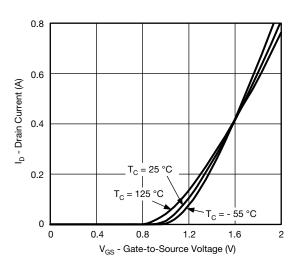
Output Characteristics



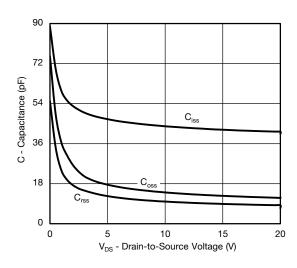
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage



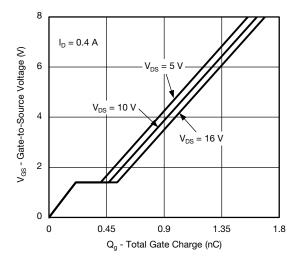
Transfer Characteristics



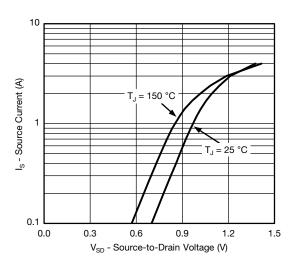
Capacitance



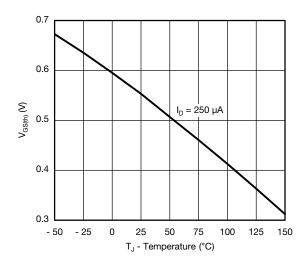
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



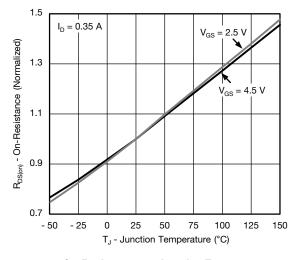
Gate Charge



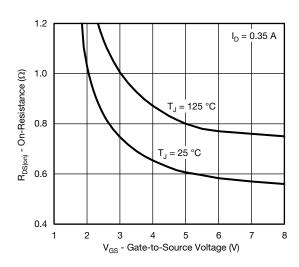
Source-Drain Diode Forward Voltage



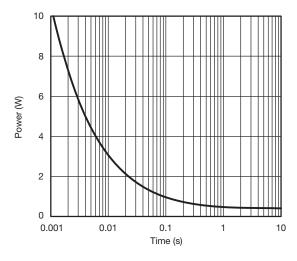
Threshold Voltage



On-Resistance vs. Junction Temperature



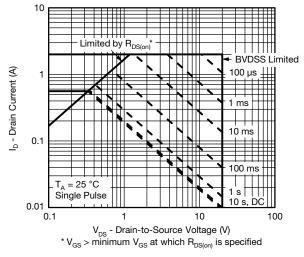
On-Resistance vs. Gate-to-Source Voltage

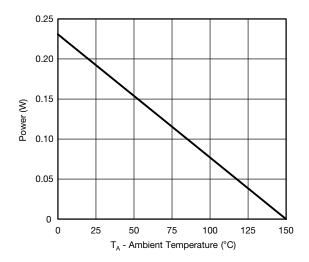


Single Pulse Power, Junction-to-Ambient



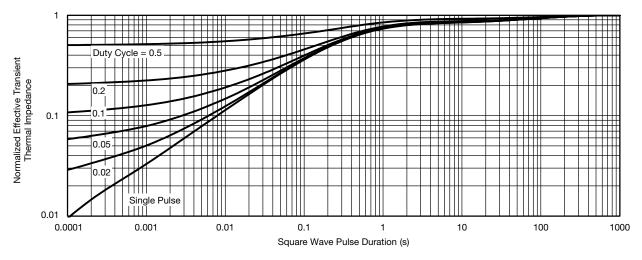
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Safe Operating Area, Junction-to-Ambient

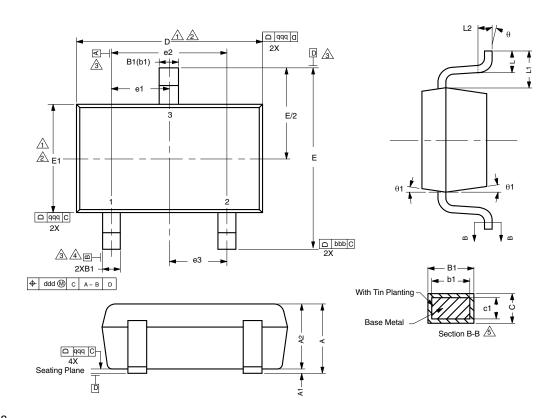
Power Derating, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



SC-75: 3 Leads



DWG: 5868

Notes

Dimensions in millimeters will govern.

Dimension D does not include mold flash, protrusions or gate burrs. Mold flash protrusions or gate burrs shall not exceed 0.10 mm per end. Dimension E1 does not include Interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.10 mm per side.

Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

Datums A, B and D to be determined 0.10 mm from the lead tip.

Terminal positions are shown for reference only.

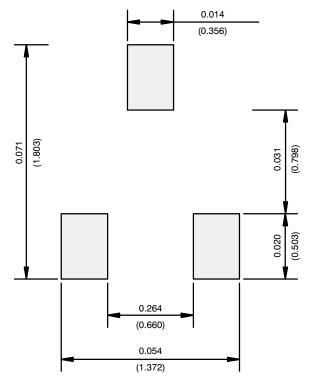
These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

DIMENSIONS	TOLERANCES
aaa	0.10
bbb	0.10
ccc	0.10
ddd	0.10

DIM		NOTE		
DIM.	MIN.	NOM.	MAX.	NOTE
Α	-	-	0.80	
A1	0.00	-	0.10	
A2	0.65	0.70	0.80	
B1	0.19	-	0.24	5
b1	0.17	-	0.21	
С	0.13	-	0.15	5
c1	0.10	-	0.12	5
D	1.48	1.575	1.68	1, 2
Е	1.50	1.60	1.70	
E1	0.66	0.76	0.86	1, 2
e1	0.50 BSC			
e2	1.00 BSC			
e3	0.50 BSC			
L	0.15	0.205	0.30	
L1	0.40 ref.			
L2	0.15 BSC			
q	0°	-	8°	
q1	4°	-	10°	



RECOMMENDED MINIMUM PADS FOR SC-75: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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